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>Title: **JP2002223070A2: METHOD FOR MANUFACTURING METAL PLATE METAL CORE PRINTED WIRING BOARD AND METHOD FOR MANUFACTURING METAL CORE PRINTED WIRING BOARD**

Country: **JP Japan**

Kind: **A2 Document Laid open to Public inspection !**

Inventor: **SATO KOJI;
KUMAMOTO SHINGO;
DATE MASAYOSHI;**



Assignee: **HITACHI METALS LTD**
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Published / Filed: **2002-08-09 / 2001-01-29**

Application Number: **JP2001000019919**

IPC Code: **H05K 3/44; B21D 28/00; H05K 3/40;**

Priority Number: **2001-01-29 JP2001000019919**

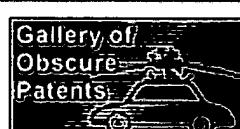
Abstract: **PROBLEM TO BE SOLVED: To provide a method for manufacturing a metal plate for a metal core printed wiring board and a method for manufacturing the metal core printed wiring board which make simple and inexpensive a process of manufacturing the metal core printed wiring board and also increase the density of a metal window for a through hole of a metal plate for a metal core and insulation reliability.**

SOLUTION: As for the manufacturing method for the metal plate used for the metal core printed wiring board, this manufacturing method is provided for the metal plate for the metal core printed wiring board which form the metal window for the through hole of the metal plate by punching.

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Family: None

Other Abstract Info: CHEMABS 137(10)148627C CHEMABS 137(10)148627C DERABS G2002-624072 DERABS G2002-624072



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